Technical Data
Data Sheet N2018, Rev. -

US1A THRU US1K
SURFACE MOUNT ULTRA FAST RECTIFIER

SMA

Features

- **Ideally Suited for Automatic Assembly**
- **Low Forward Overload Drop, High Efficiency**
- **Low Power Loss**
- **Super-Fast Recovery Time**
- **Plastic Material has UL Classification 94V-O**
- **This is a Pb − Free Device**
- **All SMC parts are traceable to the wafer lot**
- **Additional testing can be offered upon request**

Circuit Diagram

Mechanical Data

- **Case: Low Profile Molded Plastic**
- **Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026**
- **Polarity: Cathode Band or Cathode Notch**
- **Weight: 0.06 grams(approx)**

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	US1A	US1B	US1D	US1G	US1J	US1K	Units
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	
Average Rectified Output Current @T_L =100°C	Io	1.0						A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	35						A
Rating for fusing (t<8.3ms)	I^2t	5.08						A^2s
Forward voltage @IF =1.0A	V_F	1.0			1.3	1.7		V
Peak Reverse Current @T_A = 25°C At Rated DC Blocking Voltage @T_A = 125°C	I_R	5 200						μA
Typical junction capacitance (Note 1)	C_J	45.0						pF
Reverse Recovery Time (Note 2)	Trr	50				75		ns
Typical thermal resistance (Note 3)	$R_{\theta JA}$	30						°C/W
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 to +150						°C

Note: 1.Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, IRR=0.25A.
2. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C
3. 8.0mm^2 (.13mm Thick) Land Areas.

Technical Data
Data Sheet N2018, Rev. -

Ratings and Characteristics Curves

FIG.1MAXIMUM AVERAGE FORWARD CURRENT DERATING

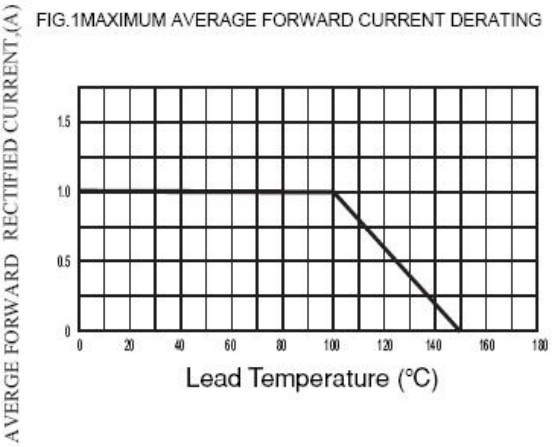


FIG.2TYPICAL FORWARD CHARACTERISTICS

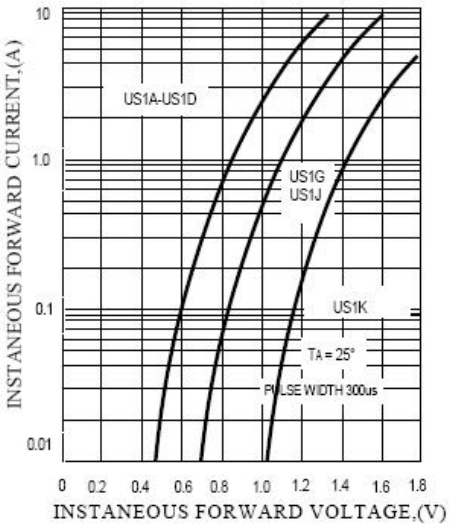


FIG.3MAXIMUM NON-REPEITIVE SURGE CURRENT

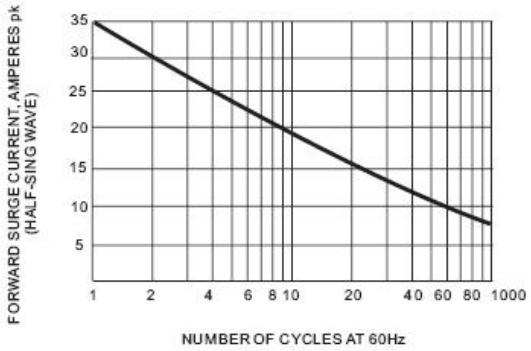


FIG.4TYPICAL JUNCTION CAPACITANCE

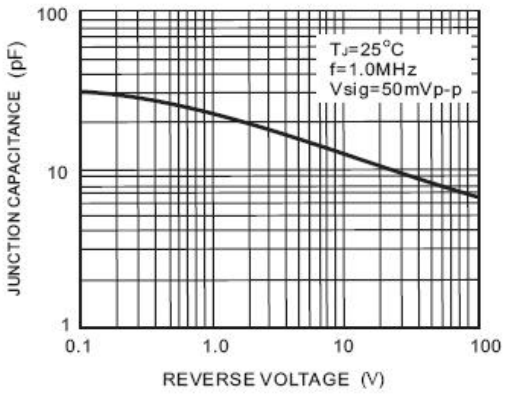
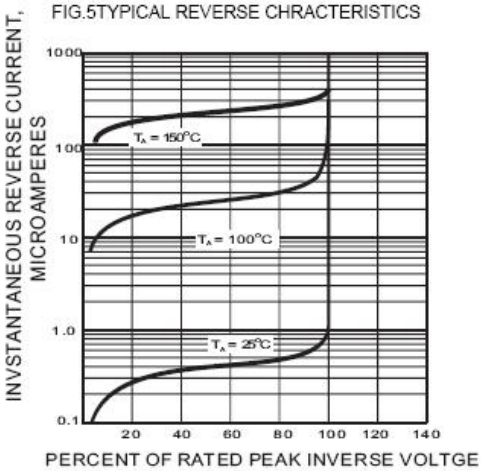
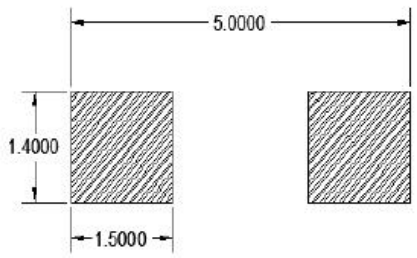


FIG.5TYPICAL REVERSE CHRACTERISTICS



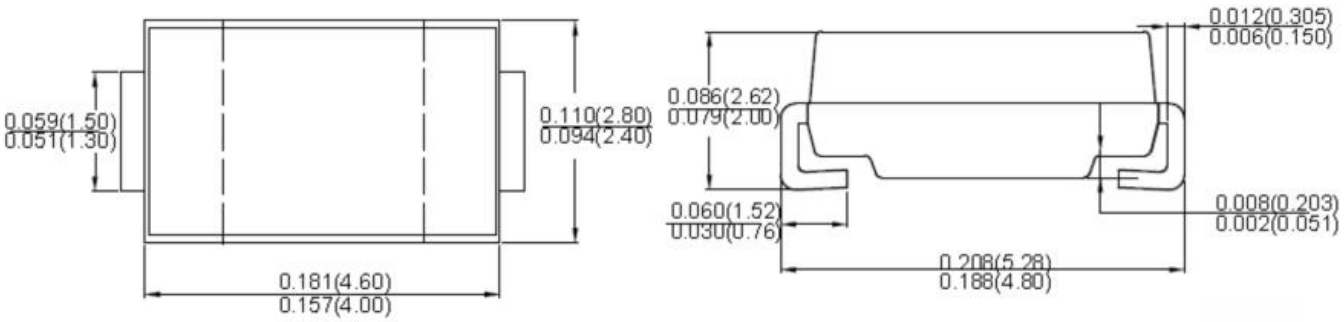
SMA PAD LAYOUT



US1A THRU US1K

Technical Data
Data Sheet N2018, Rev. -

Mechanical Dimensions SMA (Inches/Millimeters)



Ordering Information

Device	Package	Shipping
US1A THRU US1K	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

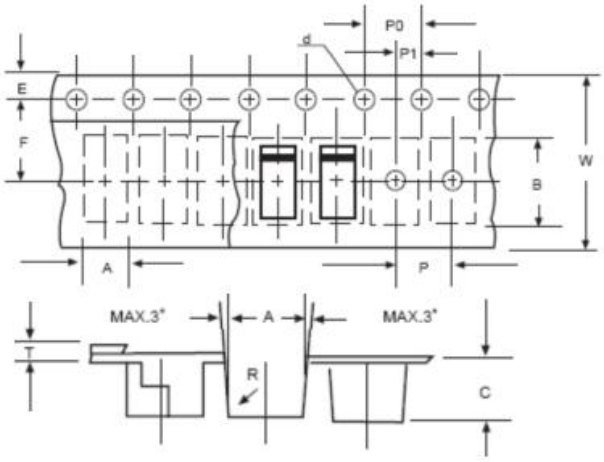
Marking Diagram

Where XXXXX is YYWWL

US	= Device Type
1	= Forward Current (1A)
A	= Reverse Voltage (50V)
YY	= Year
WW	= Week
L	= Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Carrier Tape Specification SMA



SYMBOL	Millimeters	
	Min.	Max.
A	2.97	3.17
B	5.70	5.90
C	2.32	2.52
d	1.40	1.60
E	1.40	1.60
F	5.60	5.70
P	3.90	4.10
P0	3.90	4.10
P1	1.90	2.10
T	0.25	0.35
W	11.80	12.20

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Data Sheet N2018, Rev. -

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